



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Suan J. Boon

Examiner: DiLinh Nguyen

Serial No.:

10/723,474

Group Art Unit: 2814

Filed:

Docket: 303.601US2

November 26, 2003

Title:

ELECTRONIC APPARATUS HAVING AN ADHESIVE LAYER FROM WAFER LEVEL

PACKAGING

COMMUNICATION CONCERNING RELATED APPLICATION(S)

MS RCE

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Applicant would like to bring to the Examiner's attention the following related application(s) in the aboveidentified patent application:

per	Serial/Patent No. 11460089	Filing Date/Issue Date July 26, 2006	Attorney Docket 303.601US4	Title WAFER LEVEL PRE-PACKAGED FLIP CHIP
per	11460093	July 26, 2006	303.601US5	WAFER LEVEL PRE-PACKAGED FLIP CHIP
per2	11460435	July 27, 2006	303.601US6	WAFER LEVEL PRE-PACKAGED FLIP CHIP SYSTEMS
per	11460445	July 27, 2006	303.601US7	WAFER LEVEL PRE-PACKAGED FLIP CHIP SYSTEM

Continuations and divisionals may be later filed on the cases listed above, or cited to the Examiner in any previous Communication Concerning Related Applications. Applicants request that the Examiner review all continuations and divisionals of the above-listed or previously-cited patent applications before allowing the claims of the present patent application.

> Respectfully submitted, SUAN J. BOON By Applicant's Representatives, SCHWEGMAN, LUNDBERG, WOESSNER & KLUTH, P.A. P.O. Box 2938 Minneapolis, MN 55402 612-373-6900

Reg. No. 57,521

CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Mail Stop RCE, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on this 2 day of August 2006.

SEP NG 2006 W

PTO/SE/08A(10-01
Approved for use through 10/31/2002, OMB 651-0031
Patent & Tradenters Office: U.S. DEPARTMENT OF COMMERCE

for form 1449A/PTO Complete if Known **ÖRMATION DISCLOSURE** 10/723,474 **Application Number** STATEMENT BY APPLICANT November 26, 2003 Filing Date (Use as many sheets as necessary) Boon, Suan First Named Inventor 2814 **Group Art Unit** Nguyen, DiLinh **Examiner Name** Attorney Docket No: 303.601US2 Sheet 1 of 1

US PATENT DOCUMENTS						
Examiner Initial	USP Document Number	Publication Date	Name of Patentee or Applicant of cited Document	Filing Date If Appropriate		
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/	US-6,063,646	05/16/2000	Okuno, A., et al.	10/06/1998		
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FOREIGN PATENT DOCUMENTS							
Examiner Initials*	Foreign Document No	Publication Date	Name of Patentee or Applicant of cited Document	T²			

OTHER DOCUMENTS NON PATENT LITERATURE DOCUMENTS				
Examiner Initials*	Cite No ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and/or country where published.	T²	

EXAMINER

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DATE CONSIDERED

10/13/06